

# VN40AFD

N-Channel Enhancement-Mode MOS Transistor

T-39-07

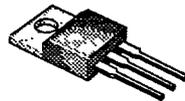
## PRODUCT SUMMARY

$V_{(BR)DSS}$ (V)	$r_{DS(ON)}$ ( $\Omega$ )	$I_D$ (A)	PACKAGE
40	5	1.14	TO-220SD

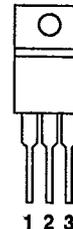
SD = Side Drain

Performance Curves: VNDQ06 (See Section 7)

TO-220SD



TOP VIEW



- 1 SOURCE
- 2 GATE
- 3 & TAB - DRAIN

## ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	VN40AFD	UNITS
Drain-Source Voltage	$V_{DS}$	40	V
Gate-Source Voltage	$V_{GS}$	$\pm 30$	
Continuous Drain Current	$I_D$	$T_C = 25^\circ\text{C}$	A
		$T_C = 100^\circ\text{C}$	
Pulsed Drain Current <sup>1</sup>	$I_{DM}$	3	
Power Dissipation	$P_D$	$T_C = 25^\circ\text{C}$	W
		$T_C = 100^\circ\text{C}$	
Operating Junction and Storage Temperature	$T_j, T_{stg}$	-55 to 150	$^\circ\text{C}$
Lead Temperature (1/16" from case for 10 seconds)	$T_L$	300	

**6**

## THERMAL RESISTANCE

THERMAL RESISTANCE	SYMBOL	VN40AFD	UNITS
Junction-to-Case	$R_{thJC}$	8.3	$^\circ\text{C}/\text{W}$

<sup>1</sup>Pulse width limited by maximum junction temperature.

## VN40AFD

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ELECTRICAL CHARACTERISTICS <sup>1</sup>				LIMITS		
PARAMETER	SYMBOL	TEST CONDITIONS	TYP <sup>2</sup>	VN40AFD		UNIT
				MIN	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0 \text{ V}, I_D = 10 \mu\text{A}$	70	40		V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	1.5	0.8	2.5	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 15 \text{ V}$	$\pm 1$		$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$	0.05		10	$\mu\text{A}$
		$V_{DS} = 32 \text{ V}, V_{GS} = 0 \text{ V}, T_C = 125^\circ\text{C}$	0.3		500	
On-State Drain Current <sup>3</sup>	$I_{D(ON)}$	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}$	1.8	1		A
Drain-Source On-Resistance <sup>3</sup>	$r_{DS(ON)}$	$V_{GS} = 5 \text{ V}, I_D = 0.3 \text{ A}$	1.8		5	$\Omega$
		$V_{GS} = 10 \text{ V}, I_D = 1 \text{ A}$	1.3		5	
		$T_C = 125^\circ\text{C}$	2.6		10	
Forward Transconductance <sup>3</sup>	$g_{FS}$	$V_{DS} = 10 \text{ V}, I_D = 0.5 \text{ A}$	350	170		mS
Common Source Output Conductance <sup>3</sup>	$g_{OS}$	$V_{DS} = 10 \text{ V}, I_D = 0.1 \text{ A}$	1100			$\mu\text{S}$
<b>DYNAMIC</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 25 \text{ V}$ $V_{GS} = 0 \text{ V}$ $f = 1 \text{ MHz}$	35		50	pF
Output Capacitance	$C_{oss}$		25		65	
Reverse Transfer Capacitance	$C_{rss}$		5		10	
<b>SWITCHING</b>						
Turn-On Time	$t_{ON}$	$V_{DD} = 25 \text{ V}, R_L = 23 \Omega$ $I_D = 1 \text{ A}, V_{GEN} = 10 \text{ V}$ $R_G = 25 \Omega$ (Switching time is essentially independent of operating temperature)	8		15	ns
Turn-Off Time	$t_{OFF}$		9.5		15	

- NOTES: 1.  $T_A = 25^\circ\text{C}$  unless otherwise noted.  
 2. For design aid only, not subject to production testing.  
 3. Pulse test;  $PW = 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .